



SBR1A400P1

#### **1.0A SBR** SURFACE MOUNT SUPER BARRIER RECTIFIER PowerDI123

#### **Features**

- Ultra-Low Forward Voltage Drop
- Low Leakage Current
- Superior Reverse Avalanche Capability
- **Excellent High-Temperature Stability**
- Patented Interlocking Clip Design for High Surge Current Capacity
- Patented Super Barrier Rectifier Technology (SBR®)
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: PowerDI<sup>®</sup>123
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity Indicator: Cathode Band
- Terminals: Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (93)
- Weight: 0.018 grams (Approximate)

PowerDI123



Top View

### **Ordering Information** (Note 4)

Part Number	Case	Packaging
SBR1A400P1-7	PowerDI123	3,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**

PowerDI123



SDE = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018)M = Month (ex: 3 = March)

Date Code Key

Year	201	5	2016		2017	20	18	2019		2020		2021
Code	С		D		Е		-	G		Н		I
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

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Document number: DS37709 Rev. 3 - 2



## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>RM</sub>	400	٧
Average Rectified Output Current (See Figure 1)	lo	1.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	40	А

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Junction to Ambient (Note 5)	R <sub>θJA</sub>	138	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

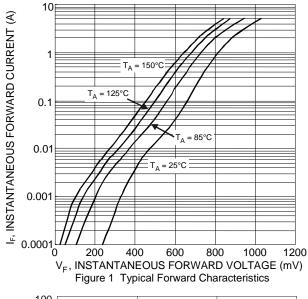
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage	V <sub>F</sub>	_	0.88	1.1 1.0	V	I <sub>F</sub> = 1.0A, T <sub>J</sub> = +25°C
		_		0.05		$I_F = 1.0A$ , $T_J = +125$ °C $V_R = 400V$ , $T_J = +25$ °C
Reverse Current (Note 6)	IR	1	0.013 0.073	0.36 2	mA	$V_R = 400V, T_J = +85^{\circ}C$ $V_R = 400V, T_J = +125^{\circ}C$
Reverse Recovery Time	t <sub>RR</sub>	_	_	85	ns	$I_F = 0.5A, I_R = 1A,$ $I_{RR} = 0.25A$

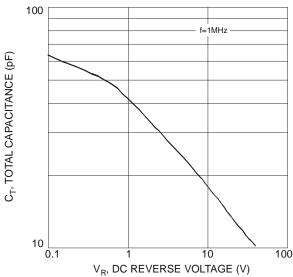
Notes:

<sup>5.</sup> FR-4 substrate PC board, with minimum recommended pad layout per http://www.diodes.com/package-outlines.html.

<sup>6.</sup> Short duration pulse test used to minimize self-heating effect.







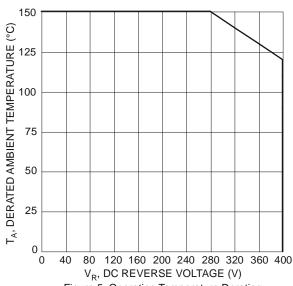
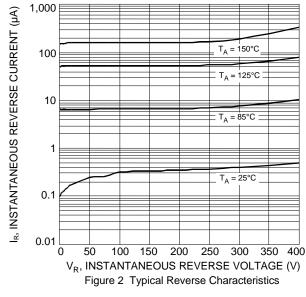


Figure 3 Total Capacitance vs. Reverse Voltage



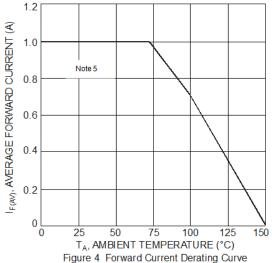


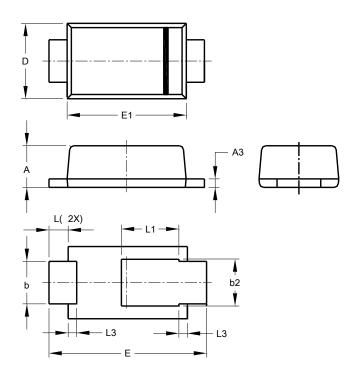
Figure 5 Operating Temperature Derating



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI123

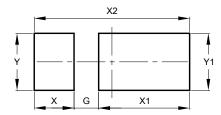


PowerDI123					
Dim	Min	Max	Тур		
Α	0.93	1.00	0.98		
A3	0.15	0.25	0.20		
b	0.85	1.25	1.00		
b2	1.025	1.125	1.10		
D	1.63	1.93	1.78		
Е	3.50	3.90	3.70		
E1	2.60	3.00	2.80		
L	0.40	0.50	0.45		
L1	1.25	1.40	1.35		
L3	0.125	0.275	0.20		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI123



Dimensions	Value (in mm)		
G	0.65		
Х	1.05		
X1	2.40		
X2	4.10		
Y	1.50		
Y1	1.50		



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